

Features

- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Lead Free Finish/RoHS Compliant (Note 2)("P" Suffix Designates RoHS Compliant. See Ordering Information)
- For Surface Mount Application
- High Current Capability

Maximum Ratings @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Value									Unit
		SK 52 B-L	SK 53 B-L	SK 54 B-L	SK 55 B-L	SK 56 B-L	SK 58 B-L	SK 510 B-L	SK 5150 B-L	SK 520 B-L	
Peak Repetitive Reverse Voltage	V_{RRM}										V
Working Peak Reverse Voltage	V_{RWM}	20	30	40	50	60	80	100	150	200	
DC Blocking Voltage	V_R										
RMS Reverse Voltage	V_{RMS}	14	21	28	35	42	56	70	105	140	V
Average Rectified Forward Current	$I_{F(AV)}$	5									A
Non-Repetitive Peak Surge Current @ 8.3ms Half Sine Wave	I_{FSM}	100									A
Current Squared Time @ 1ms ≤ t ≤ 8.3ms	I^2t	41.5									A ² s

Marking Code

Part Number	Marking Code
SK52B-L	SK52B
SK53B-L	SK53B
SK54B-L	SK54B
SK55B-L	SK55B
SK56B-L	SK56B
SK58B-L	SK58B
SK510B-L	SK510B
SK5150B-L	SK5150
SK520B-L	SK520B

Internal Structure

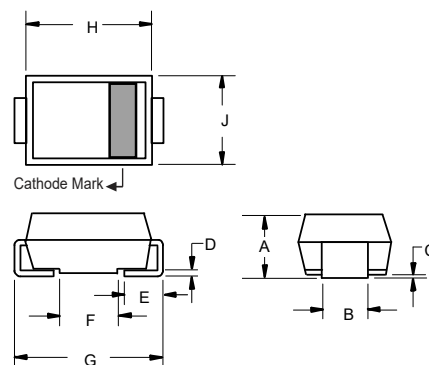
Pin	Description	Simplified Outline	Graphic Symbol
1	Cathode		
2	Anode		

Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

2. High temperature solder exemption applied, see EU directive annex 7a.

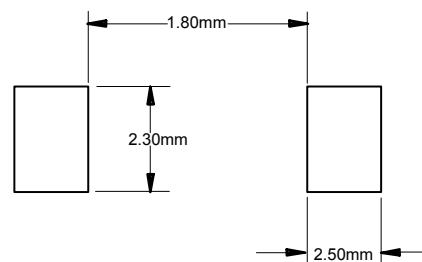
5 Amp
'GW ch_mIF YWjZYf
&0 to &00 Volts

SMB(DO-214AA)



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.079	0.103	2.00	2.62	
B	0.075	0.087	1.91	2.21	
C	0.002	0.008	0.05	0.20	
D	0.006	0.012	0.15	0.31	
E	0.030	0.060	0.76	1.52	
F	0.065	0.091	1.65	2.32	
G	0.200	0.220	5.08	5.59	
H	0.160	0.191	4.06	4.85	
J	0.130	0.155	3.30	3.94	

Suggested Solder Pad Layout



Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_J	Operating Junction Temperature Range		-55		150	°C
T_{stg}	Storage Temperature Range		-55		150	°C
$R_{th(J-L)}$	Thermal Resistance from Junction to Lead	Note 1		20		°C/W
$R_{th(J-A)}$	Thermal Resistance from Junction to Ambient	Note 1		75		°C/W

Note:

1. Mounted on P.C.B. with 8mm*8mm copper pad areas.

Electrical Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Forward Voltage SK52B-L ~ SK54B-L SK55B-L ~ SK56B-L SK58B-L ~ SK510B-L SK5150B-L SK520B-L	V_F	$I_F=5A; T_J=25^\circ C$			0.55 0.70 0.85 0.87 0.90	V
Reverse Current SK52B-L ~ SK56B-L SK58B-L ~ SK520B-L	I_R	at Rated $V_R; T_J=25^\circ C$ at Rated $V_R; T_J=125^\circ C$ at Rated $V_R; T_J=25^\circ C$ at Rated $V_R; T_J=125^\circ C$			0.1 20 0.01 2	mA
Junction Capacitance SK52B-L ~ SK54B-L SK55B-L ~ SK56B-L SK58B-L ~ SK510B-L SK5150B-L ~ SK520B-L	C_J	$V_R=4V; f=1MHz; T_J=25^\circ C$		275 195 135 95		pF

Curve Characteristics

Fig. 1 - Forward Current Derating Curve

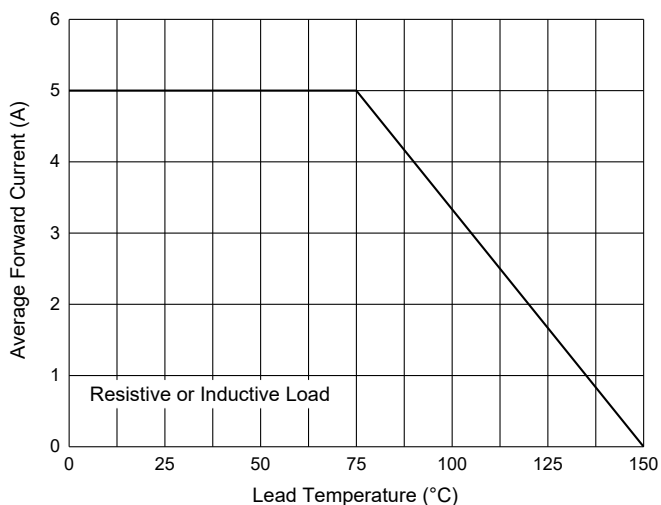


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

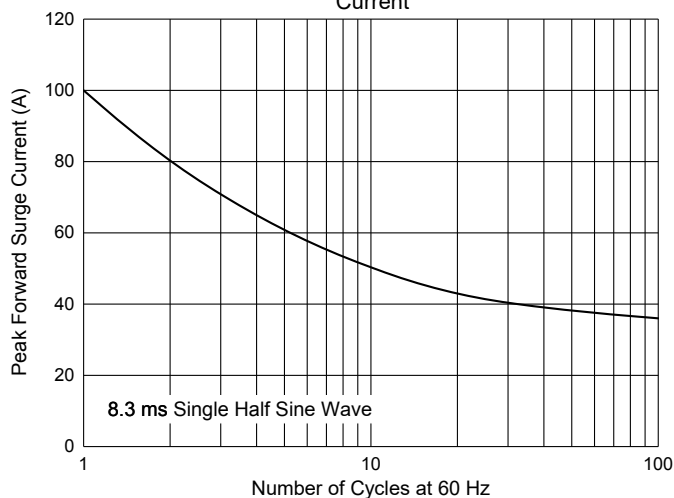


Fig. 3 - Typical Forward Characteristics

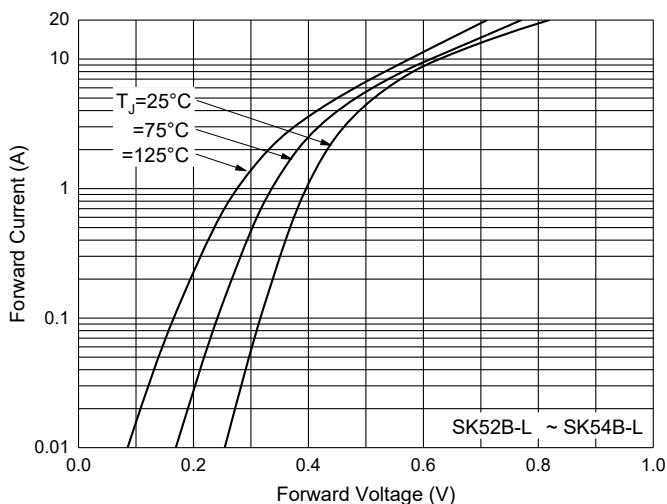


Fig. 4 - Typical Reverse Leakage Characteristics

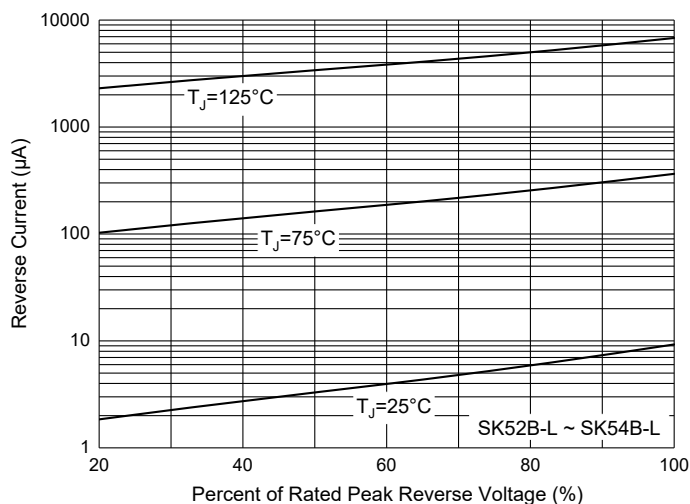


Fig. 5 - Typical Forward Characteristics

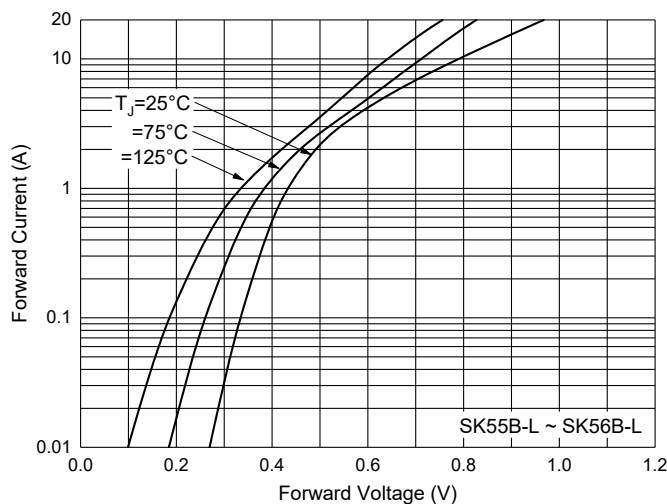
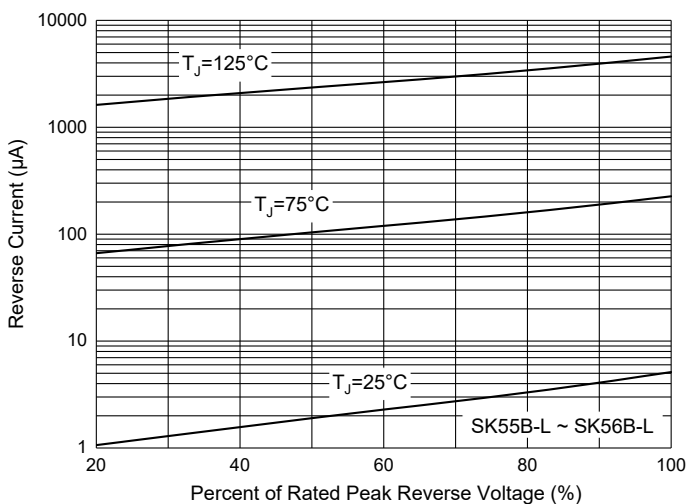


Fig. 6 - Typical Reverse Leakage Characteristics



Curve Characteristics

Fig. 7 - Typical Forward Characteristics

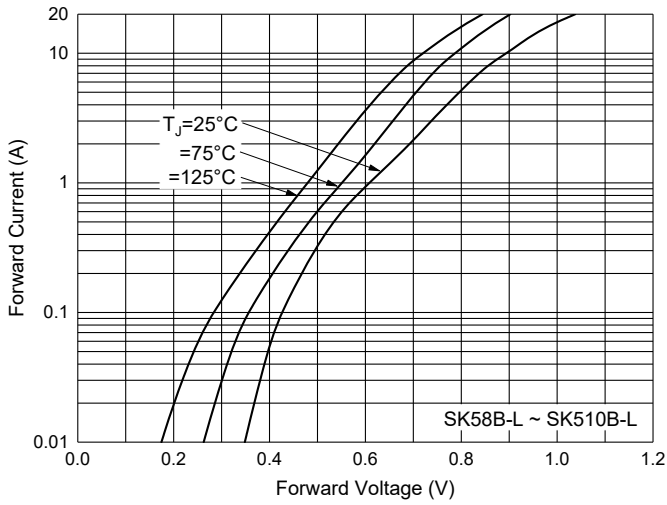


Fig. 8 - Typical Reverse Leakage Characteristics

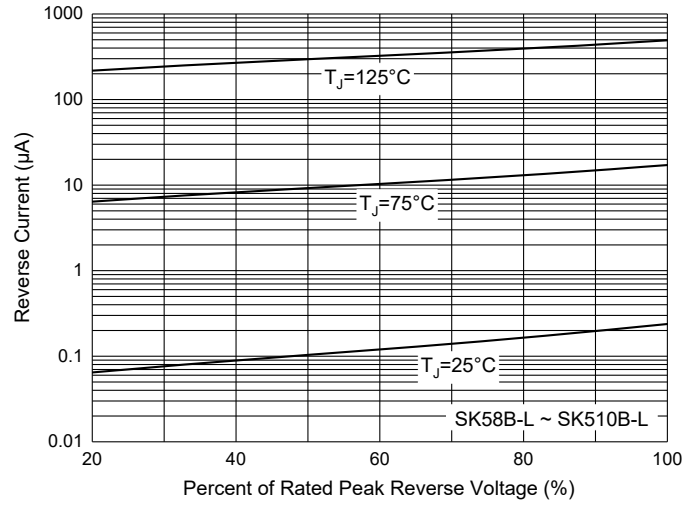


Fig. 9 - Typical Forward Characteristics

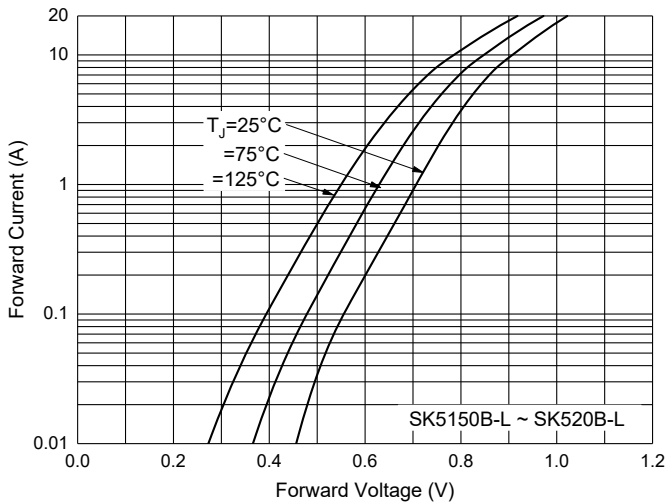


Fig. 10 - Typical Reverse Leakage Characteristics

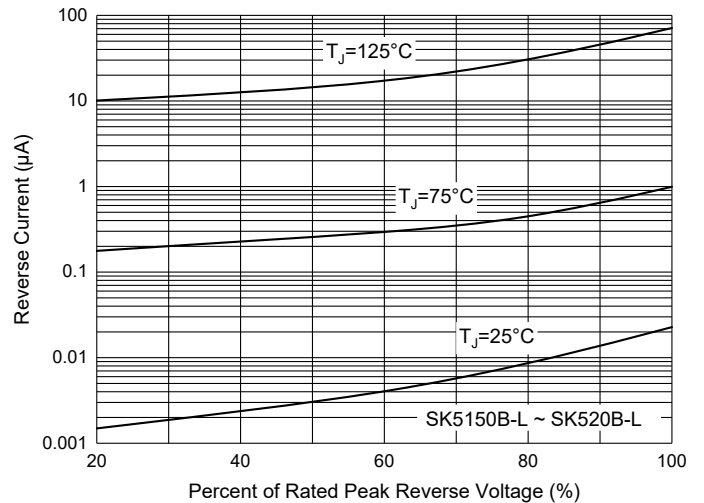


Fig. 11 - Typical Capacitance Characteristics

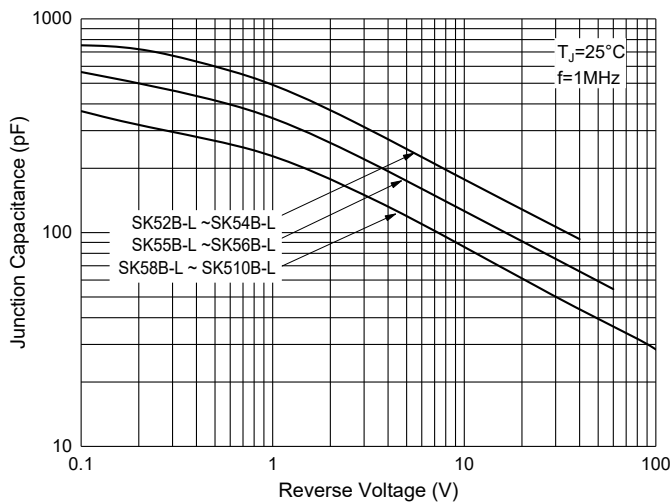
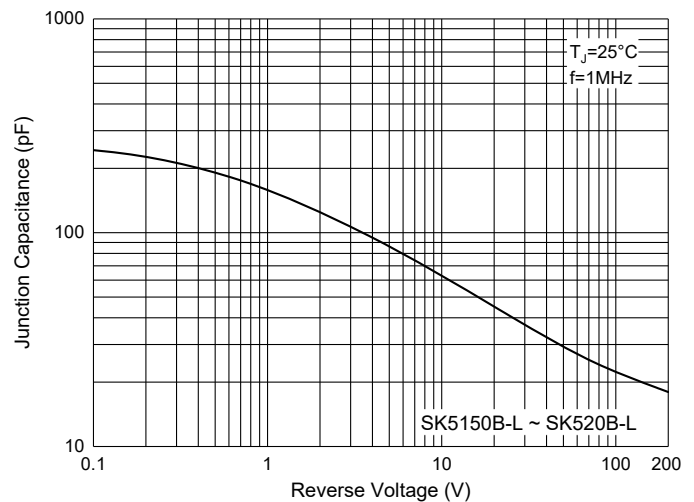


Fig. 12 - Typical Capacitance Characteristics



Ordering Information

Device	Packing
SK52B-LTP ~ SK520B-LTP	Tape&Reel:3Kpcs/Reel

*****IMPORTANT NOTICE*****

Micro Commercial Components Corp. reserves the right to make changes without further notice to any product herein to make corrections, modifications , enhancements , improvements , or other changes . *Micro Commercial Components Corp.* does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights ,nor the rights of others . The user of products in such applications shall assume all risks of such use and will agree to hold *Micro Commercial Components Corp.* and all the companies whose products are represented on our website, harmless against all damages. *Micro Commercial Components Corp.* products are sold subject to the general terms and conditions of commercial sale, as published at <https://www.mccsemi.com/Home/TermsAndConditions>.

*****LIFE SUPPORT*****

MCC's products are not authorized for use as critical components in life support devices or systems without the express written approval of Micro Commercial Components Corporation.

*****CUSTOMER AWARENESS*****

Counterfeiting of semiconductor parts is a growing problem in the industry. Micro Commercial Components (MCC) is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. MCC strongly encourages customers to purchase MCC parts either directly from MCC or from Authorized MCC Distributors who are listed by country on our web page cited below. Products customers buy either from MCC directly or from Authorized MCC Distributors are genuine parts, have full traceability, meet MCC's quality standards for handling and storage. **MCC will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources.** MCC is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.